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CST-90 LEDs





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Features:

- Extremely high optical output: Over 2,600 lumens from a single chip (White)
- Extremely high efficiency: Over 100 lumens per watt at 3.15A
- High thermal conductivity package junction to heat sink thermal resistance of only 0.92 °C/W
- Large, monolithic chip with uniform emitting area of 9 mm²
- Lumen maintenance of greater than 70% after 60,000 hours
- Environmentally friendly: RoHS compliant
- Variable drive currents: less than 1 A through 13.5 A
- High reliability

Applications

- Architectural Lighting
- Retail Lighting
- Residential Lighting
- Consumer Portable

- Spot Lighting
- High Bay Lighting
- Wide Area Lighting
- Street Lighting





Technology Overview

Luminus Big Chip LEDs™ benefit from a suite of innovations in the fields of chip technology, packaging and thermal management. These breakthroughs allow illumination engineers and designers to achieve solutions that are high brightness and high efficiency.

Photonic Lattice Technology

Luminus' photonic lattice technology enables large area LED chips with uniform brightness over the entire LED chip surface. The optical power and brightness produced by these large monolithic chips enable solutions which replace arc and halogen lamps where arrays of traditional high power LEDs cannot.

For red, green and blue LEDs, the photonic lattice structures extract more light and create radiation patterns that are more collimated than traditional LEDs. Having higher collimation from the source increases optical collection efficiencies and simplifies optical designs.

Packaging Technology

Thermal management is critical in high power LED applications. With a thermal resistance from junction to heat sink of 0.92° C/W. Luminus CST-90 LEDs have the lowest thermal resistance of any LED on the market. This allows the LED to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions

and longer lifetimes.

Reliability

Designed from the ground up, Luminus Big Chip LEDs are one of the most reliable light sources in the world today. Big Chip LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that typically exceed 60,000 hours, Luminus Big Chip LEDs are ready for even the most demanding applications.

Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All Big Chip LED products manufactured by Luminus are RoHS compliant and free of hazardous materials, including lead and mercury.

Understanding Big Chip LED Test Specifications

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

Testing Temperature

Luminus core board products are typically measured in such a way that the characteristics reported agree with how the devices will actually perform when incorporated into a system. This measurement is accomplished by mounting the devices on a 40°C heat sink and allowing the device to reach thermal equilibrium while fully powered. Only after the device reaches equilibrium are the measurements taken. This method of measurement ensures that Luminus Big Chip LEDs perform in the field just as they are specified.

Luminus surface mount LEDs are typically tested with a 20mSec input pulse and a junction temperature of 25°C. Expected flux values in real world operation can be extrapolated based on the information contained within this product data sheet.

Multiple Operating Points (3.15, 13.5 A)

The tables on the following pages provide typical optical and electrical characteristics. Since the LEDs can be operated over a wide range of drive conditions (currents from less than 1.0 A to 13.5 A, and duty cycle from <1% to 100%), multiple drive conditions are listed.

CST-90 LEDs are production tested at 3.15 A. The values shown at 13.5 are for additional reference at other possible drive conditions.



CST-90 White Binning Structure

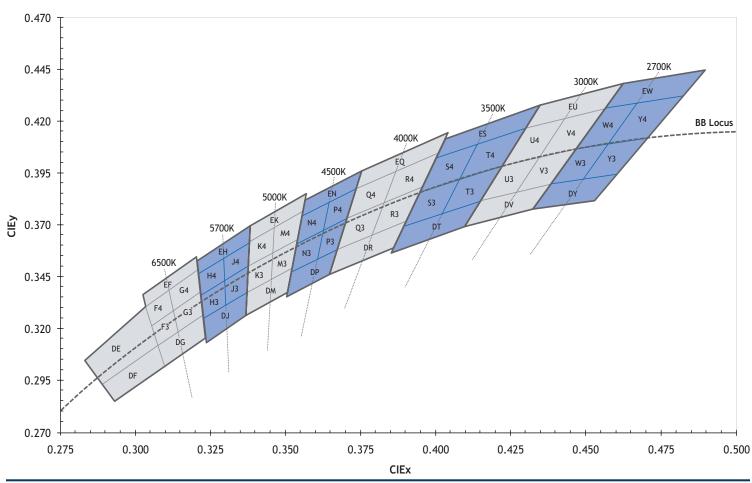
CST-90 LEDs are tested for luminous flux and chromaticity at a drive current of 3.15 A (350 mA/mm²) and placed into one of the following luminous flux (FF) and chromaticity (WW) bins:

Flux Bins

Flux Bin (FF)	Minumum Flux (lm) @ 3.15A	Maximum Flux (lm) @ 3.15A
К	500	600
L	600	700
M	700	850
N	850	1,000

^{*}Note: Luminus maintains a +/- 6% tolerance on flux measurements.

Chromaticity Bins
Luminus' Standard Chromaticity Bins: 1931 CIE Curve







The following tables describe the four chromaticity points that bound each chromaticity bin. Chromaticity bins are grouped together based on the color temperature.

6500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.307	0.311	
DG	0.322	0.326	
	0.323	0.316	
	0.309	0.302	
	0.305	0.321	
F3*	0.313	0.329	
13	0.315	0.319	
	0.307	0.311	
	0.303	0.330	
F4*	0.312	0.339	
[[4	0.313	0.329	
	0.305	0.321	
	0.313	0.329	
G3*	0.321	0.337	
d3	0.322	0.326	
	0.315	0.319	
	0.312	0.339	
G4*	0.321	0.348	
G4"	0.321	0.337	
	0.313	0.329	
	0.302	0.335	
EF	0.320	0.354	
L EF	0.321	0.348	
	0.303	0.330	
	0.283	0.304	
DE	0.303	0.330	
DE	0.307	0.311	
	0.289	0.293	
	0.289	0.293	
DF	0.307	0.311	
DF	0.309	0.302	
	0.293	0.285	

5700K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.322	0.324	
LDJ	0.337	0.337	
	0.336	0.326	
	0.323	0.314	
	0.321	0.335	
H3*	0.329	0.342	
Пэ	0.329	0.331	
	0.322	0.324	
	0.321	0.346	
H4*	0.329	0.354	
П4"	0.329	0.342	
	0.321	0.335	
	0.329	0.342	
J3*	0.337	0.349	
15"	0.337	0.337	
	0.330	0.331	
	0.329	0.354	
J4*	0.338	0.362	
J4"	0.337	0.349	
	0.329	0.342	
	0.320	0.352	
EH	0.338	0.368	
СП	0.338	0.362	
	0.321	0.346	

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





5000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.338	0.368	
EK	0.356	0.384	
EK	0.355	0.376	
	0.338	0.362	
	0.337	0.349	
K3*	0.345	0.355	
K3"	0.345	0.343	
	0.337	0.337	
	0.338	0.362	
17.4*	0.347	0.369	
K4*	0.345	0.355	
	0.337	0.349	
	0.345	0.355	
NA2*	0.353	0.349	
M3*	0.352	0.372	
	0.344	0.343	
	0.346	0.369	
B A 4 ¥	0.355	0.376	
M4*	0.353	0.362	
	0.345	0.355	
	0.337	0.337	
DM	0.352	0.349	
DM	0.350	0.337	
	0.336	0.326	

4500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.356	0.384	
EN	0.376	0.396	
EIN	0.374	0.387	
	0.355	0.374	
	0.353	0.360	
No*	0.361	0.366	
N3*	0.359	0.352	
	0.351	0.347	
	0.355	0.374	
NIA¥	0.364	0.381	
N4*	0.361	0.366	
	0.353	0.360	
	0.361	0.366	
D2*	0.370	0.373	
P3*	0.367	0.358	
	0.359	0.352	
	0.364	0.381	
P4*	0.374	0.387	
P4*	0.370	0.373	
	0.361	0.366	
	0.351	0.347	
DD	0.367	0.358	
DP	0.364	0.346	
	0.350	0.335	

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





4000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.376	0.396	
EQ	0.404	0.414	
EQ	0.401	0.404	
	0.374	0.387	
	0.370	0.373	
O3*	0.382	0.380	
Q3*	0.378	0.365	
	0.367	0.358	
	0.374	0.387	
0.4*	0.387	0.396	
Q4*	0.382	0.380	
	0.370	0.373	
	0.382	0.380	
D2*	0.395	0.388	
R3*	0.390	0.372	
	0.378	0.365	
	0.387	0.396	
D.4*	0.401	0.404	
R4*	0.395	0.388	
	0.382	0.380	
	0.367	0.358	
DD	0.390	0.372	
DR	0.386	0.359	
	0.364	0.346	

3500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.403	0.411	
ES	0.435	0.427	
E3	0.430	0.417	
	0.400	0.402	
	0.394	0.385	
S3*	0.407	0.392	
33"	0.402	0.375	
	0.389	0.369	
	0.400	0.402	
S4*	0.415	0.409	
34"	0.407	0.392	
	0.394	0.385	
	0.407	0.392	
T3*	0.422	0.399	
13"	0.415	0.381	
	0.402	0.375	
	0.415	0.409	
T4*	0.430	0.417	
T4*	0.422	0.399	
	0.407	0.392	
	0.389	0.369	
DT	0.415	0.381	
DT	0.409	0.369	
	0.385	0.357	

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





3000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.435	0.427	
EU	0.462	0.437	
EU	0.456	0.426	
	0.430	0.417	
	0.422	0.399	
112*	0.434	0.403	
U3*	0.426	0.385	
	0.415	0.381	
	0.430	0.417	
	0.443	0.421	
U4*	0.434	0.403	
	0.422	0.399	
	0.434	0.403	
\/ > *	0.447	0.408	
V3*	0.437	0.389	
	0.426	0.385	
	0.443	0.421	
V4*	0.456	0.426	
V4"	0.447	0.408	
	0.434	0.403	
	0.415	0.381	
DV	0.437	0.389	
DV	0.431	0.377	
	0.409	0.369	

2700K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.462	0.437	
EW	0.488	0.444	
Evv	0.481	0.432	
	0.456	0.426	
	0.447	0.408	
W3*	0.458	0.410	
VV3"	0.448	0.392	
	0.437	0.389	
	0.456	0.426	
W4*	0.469	0.429	
VV4"	0.458	0.410	
	0.447	0.408	
	0.458	0.410	
\/2*	0.70	0.413	
Y3*	0.459	0.394	
	0.448	0.392	
	0.469	0.429	
\/4¥	0.481	0.432	
Y4*	0.470	0.413	
	0.458	0.410	
	0.437	0.389	
DV	0.459	0.394	
DY	0.452	0.382	
	0.431	0.377	

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008



WW

FF



Product Shipping & Labeling Information

All CST-90 white products are packaged and labeled with their respective bin as outlined in the tables from pages 3 to 7. When shipped, each package will only contain one bin. The part number designation is as follows:

			-		
Product Family	Chip Area	Color	Package Configuration	Flux Bin	Chromaticity Bin
Chip on board (Lens)	9.0 mm ²	CCT & CRI See Note 1 below	Internal Code	See page 3 for bins	See page 4-7 for bins

C12/C13

Note 1: WNNX nomenclature corresponds to the following:

90

W = White

CST

NN = color temperature, where:

65 corresponds to 6500K

X = color rendering index, where:

S (standard) corresponds to a typical CRI of 70

Note 2: Some flux and chromaticity bins may have limited availability. Application specific bin kits, consisting of multiple bins, may be available. For ordering information, please refer to page 14 and reference PDS-001849: CST-90 Binning & Labeling document.

Example:

The part number CST-90-W65S-C12-GN-G4 refers to a 6500K standard CRI white, CST-90 emitter, with a flux range from 850 to 1,000 lumens and a chromaticity value within the box defined by the four points (0.313, 0.338), (0.321, 0.348), (0.322, 0.336), (0.312, 0.328).



Electrical Characteristics¹

Optical and Electrical Characteristics (T, = 25 °C)

Drive Condition ²		3.15 A	13.5 A	
Parameter	Symbol	Values at Test Currents	Typical Values at Indicated Current ³	Unit
Current Density	j	0.35	1.5	A/mm ²
	V _{F, min}	2.5		V
Forward Voltage	$V_{F, typ}$	3.25	3.9	V
	V _{F, max}	3.9		V

Common Characteristics

Parameter	Symbol	Values	Unit
Viewing Angle	2 θ _{1/2}	95	
Emitting Area		9.0	mm²
Emitting Area Dimensions		3 x 3	mm×mm
Forward Voltage Temperature Coefficient⁴		-4.4	mV/°C

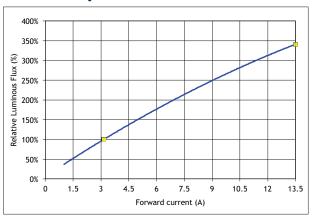
Absolute Maximum Ratings

Parameter	Symbol	Values	Unit
Maximum Current⁵		13.5	А
Maximum Reverse Current		N/A	
Maximum Junction Temperature ⁶	T _{j-max}	150	°C
Storage Temperature Range		-40/+100	°C

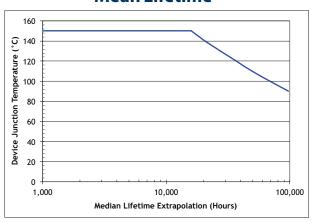
- Note 1: Listed drive conditions are typical for common applications. CST-90 white devices can be driven at currents ranging from <1A to 3.5A and at duty cycles ranging from <1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 2: Unless otherwise noted, values listed are typical.
- Note 3: Forward voltage temperature coefficient at 3.15A. Contact Luminus for value at other drive conditions.
- Note 4: CST-90 white devices are designed for operation to an absolute maximum forward drive current 13.5A. Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.
- Note 5: Lifetime dependent on LED junction temperature. Thermal calculations based on input power and thermal management system should be performed to ensure T_i is maintained below T_{imax} rating or life will be reduced. Refer to reliability application note for further information.
- Note 6: CIE measurement uncertainty for white devices is estimated to be \pm 0.01.
- Note 7: Special design considerations must be observed for operation under 1A. Please contact Luminus for further information.
- Note 8: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.



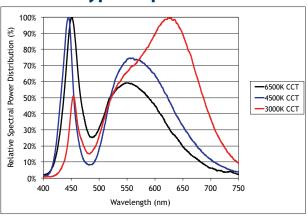
Relative Output Flux vs. Forward Current¹



Mean Lifetime²



Typical Spectrum⁴



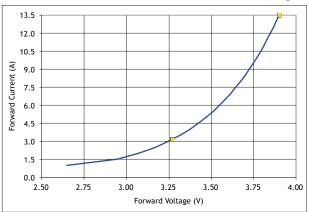
Note 1: Yellow squares indicate typical operating conditions.

Note 2: Mean expected lifetime in dependence of junction temperature at 0.35 A/mm² in continuous operation. Lifetime defined as time to 70% of initial intensity. Based on lifetime test data of uncoated GaN devices at this time. Data can be used to model failure rate over typical product lifetime (contact Luminus for lifetime reliability test data for 1A/mm² condition).

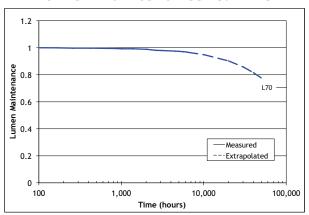
Note 3: Lumen maintenance in dependence of time at $0.35 \, \text{A/mm}^2$ in continuous operation with junction temperatures of $100 \, ^{\circ}\text{C}$.

Note 4: Typical spectrum at current density of 0.35 A/mm² in continuous operation.

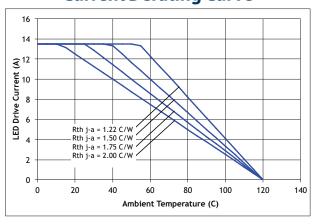
Forward Current vs. Forward Voltage



Lumen Maintenance vs. Time³

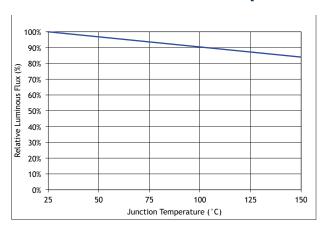


Current Derating Curve



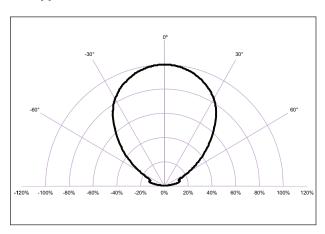


Relative Flux vs. Junction Temperature

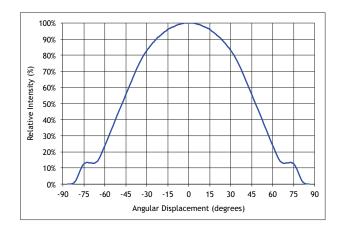


Typical Radiation Patterns

Typical Polar Radiation Pattern for White



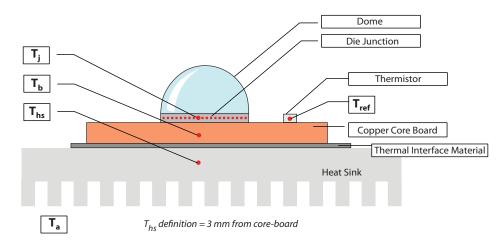
Typical Angular Radiation Pattern for White







Thermal Resistance



Typical Thermal Resistance, junction to case

R _{j-b} ¹	0.80 °C/W
R _{j-hs} 1	0.12 °C/W
R _{j-hs} ²	0.92 °C/W
R _{0-ref} 1	0.83 °C/W

Note 1: Thermal resistance values are based on FEA model results correlated to measured $R_{\theta_i + h_S}$ data.

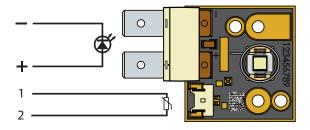
Note 2: Thermal resistance is measured using a SAC305 solder, a Bergquist Al-clad MCPCB, and eGraf 1205 thermal interface material.

Thermistor Information

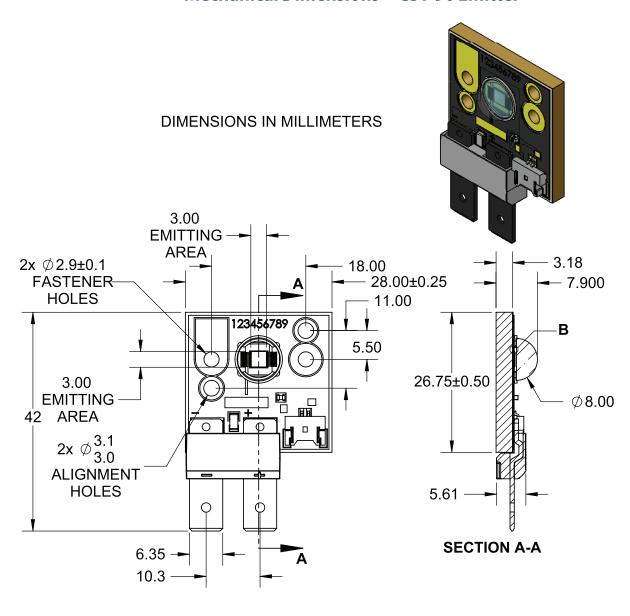
The thermistor used in CST-90 devices mounted on coreboards is from Murata Manufacturing Co. The global part number is NCP15XH103J03RC. Please see http://www.murata.com/ for details on calculating thermistor temperature.

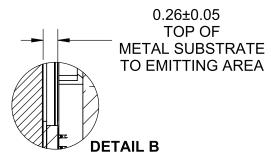
Thermistor is mounted on C13 package configuration only. See page 8 for more information.

Electrical Pinout



Mechanical Dimensions - CST-90 Emitter





Recommended connector for Anode and Cathode: Panduit Disco Lok™ Series P/N: DNG14-250FL-C. Thermistor Connector: MOLEX P/N 53780-0270. Recommended Female: MOLEX P/N 51146-0200 or equivalent. For detailed drawing please refer to DWG-001277 document.





Ordering Information

Ordering Part Number 1,2	Color	Description	
CST-90-WDLS-C12-GN150	6500K White 5700K White		
CST-90-WCLS-C12-GL450	4500K White 4000K White	White Big Chip LED™ CST-90 consisting of a 9 mm² LED, connector, mounted on a copper-core PCB	
CST-90-WWRM-C12-GK750	3000K White 2700K White		
CST-90-WDLS-C13-GN150	6500K White 5700K White		
CST-90-WCLS-C13-GL450	4500K White 4000K White	White Big Chip LED™ CST-90 consisting of a 9 mm² LED, connector, mounted on a copper-core PCB with an on board thermistor	
CST-90-WWRM-C13-GK750	3000K White 2700K White		

Note 1: GN150 - denotes a bin kit comprising of all flux and chromaticity bins at the 6500K and 5700K color points

GM450 - denotes a bin kit comprising of all flux and chromaticity bins at the 4500K and 4000K color points

GK750 - denotes a bin kit comprising of all flux and chromaticity bins at the 3000K and 2700K color points

Note 2: For ordering information on all available bin kits, please see PDS-001849: CST-90 Binning & Labeling document.

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